

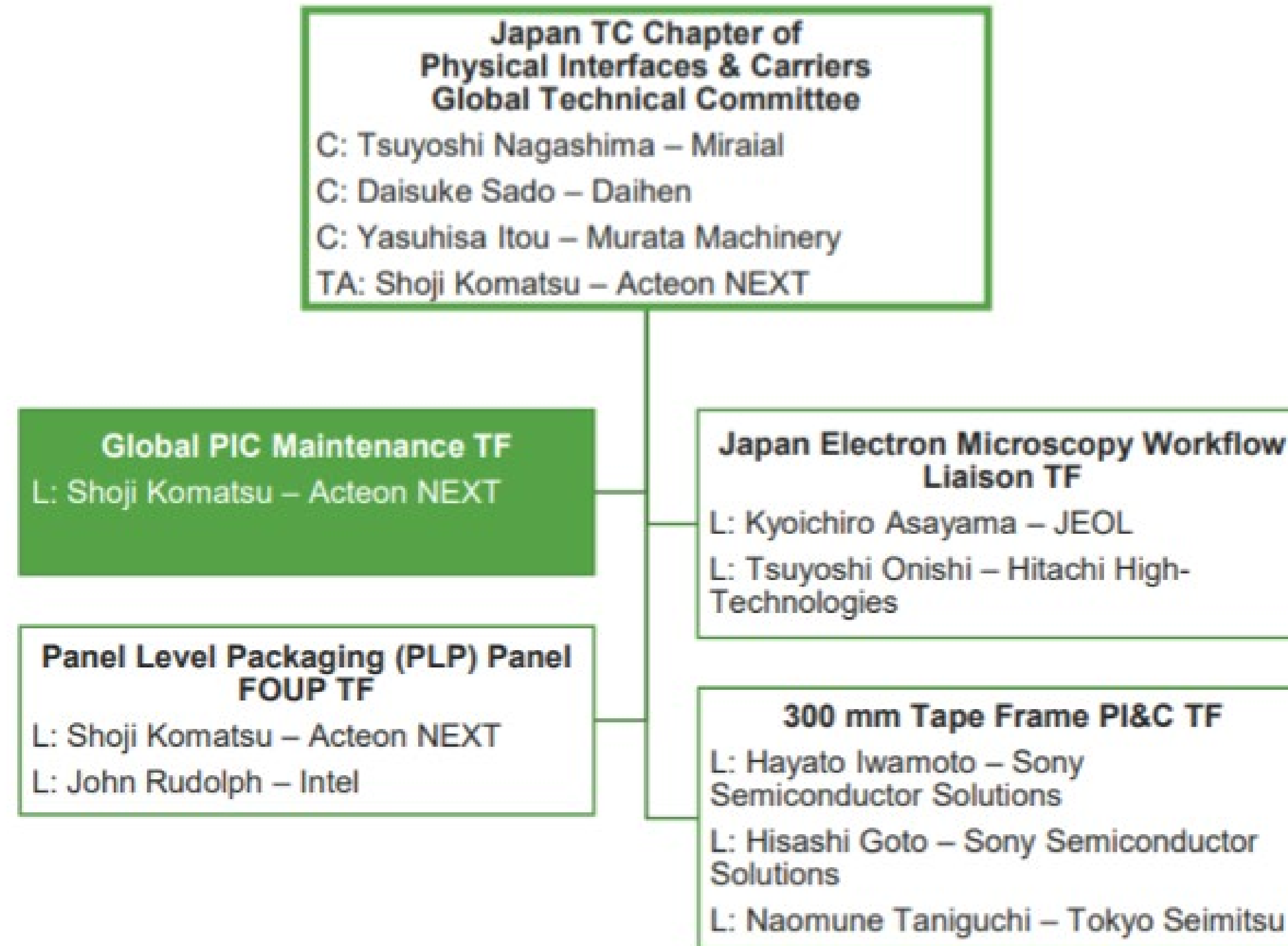
Japan TC Chapter of PI&C Global Technical Committee

**Liaison Report
2021.02.01**

Meeting Information

- Last meeting
 - December 22, 2020
 - SEMI Japan, Tokyo, Japan
 - Official Virtual TC Chapter Meeting
- Next meeting
 - April 14, 2021
 - SEMI Japan, Tokyo, Japan
 - Official Virtual TC Chapter Meeting

Organization Chart



 = Global Task Force

Ballot Results



<i>Doc #</i>	<i>Document Title</i>	<i>Committee Action</i>
6684	New Standard: Specification for Panel FOUP Loadport for Panel Level Packaging	Passed with technical changes. Ratification ballot will be issued
6685	New Subordinate Standard: Specification for Panel FOUP Loadport for 510mm-515mm Panel Size	Passed as balloted
6686	New Subordinate Standard: Specification for Panel FOUP Loadport for 600mm-600mm Panel Size	Passed as balloted

Authorized Ballots

Doc #	Cycle	SC/TF/WG	Details
6688	Cycle 1-21	300mm Tape Frame PI&C Task Force	New Standard: Specification for 300mm Tape Frame FOUP Load Port
6689	Cycle 1-21	300mm Tape Frame PI&C Task Force	New Standard: Specification for 300mm Tape Frame FOUP
R6684	Cycle 1-21	-	New Standard: Specification for Panel FOUP Loadport for Panel Level Packaging (Ratification ballot)

Thank you!!

Hirofumi Kanno (Mr.)

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Announcements

- None

Leadership Changes

- None

Committee Structure Changes

- None

Activities Approved via GCS between Meetings

- None

Authorized Activities

- None

Other Activities Outside the Letter Ballot Process

- None

Authorized Ballots

- None

Task Force Highlights

- None

Other Topics

- None

Open SNARF(s)

- None

Five-Year Review

- None